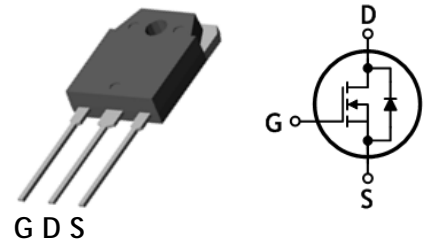


SWITCHING REGULATOR APPLICATION

Features

- Drain-Source breakdown voltage: $BV_{DSS} = 500V$
- Low gate charge: $Q_g = 33nC$ (Typ.)
- Low drain-source On resistance: $R_{DS(on)} = 0.46\Omega$ (Max.)
- 100% avalanche tested
- RoHS compliant device

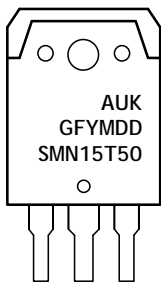


Ordering Information

Part Number	Marking	Package
SMN15T50CI	SMN15T50	TO-3P

TO-3P

Marking Information



Column 1: Manufacturer
 Column 2: Production Information
 e.g.) GFYMDD
 -. G: Option Code (H: Halogen Free)
 -. F: Factory Management Code
 -. YMDD: Date Code (Year, Month, Date)
 Column 3: Device Code

Absolute maximum ratings ($T_c = 25^\circ C$ unless otherwise noted)

Characteristic	Symbol	Rating	Unit	
Drain-source voltage	V_{DSS}	500	V	
Gate-source voltage	V_{GSS}	± 30	V	
Drain current (DC) *	I_D	$T_c = 25^\circ C$	14	A
		$T_c = 100^\circ C$	8.85	A
Drain current (Pulsed) *	I_{DM}	56	A	
Single pulsed avalanche energy ^(Note 2)	E_{AS}	642	mJ	
Repetitive avalanche current ^(Note 1)	I_{AR}	14	A	
Repetitive avalanche energy ^(Note 1)	E_{AR}	19.8	mJ	
Power dissipation	P_D	198	W	
Peak diode recovery dv/dt ^(Note 3)	dv/dt	4.5	V/ns	
Junction temperature	T_J	150	$^\circ C$	
Storage temperature range	T_{stg}	-55~150	$^\circ C$	

* Limited only maximum junction temperature

Thermal Characteristics

Characteristic	Symbol	Rating	Unit
Thermal resistance, junction to case	$R_{th(j-c)}$	Max. 0.63	°C/W
Thermal resistance, junction to ambient	$R_{th(j-a)}$	Max. 40	

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Drain-source breakdown voltage	BV_{DSS}	$I_D=250\mu\text{A}, V_{GS}=0$	500	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$I_D=250\mu\text{A}, V_{DS}=V_{GS}$	2	-	4	V
Drain-source cut-off current	I_{DSS}	$V_{DS}=500\text{V}, V_{GS}=0\text{V}$	-	-	1	μA
		$V_{DS}=400\text{V}, T_C=125^\circ\text{C}$	-	-	10	μA
Gate leakage current	I_{GSS}	$V_{DS}=0\text{V}, V_{GS}=\pm 30\text{V}$	-	-	± 100	nA
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}, I_D=7\text{A}$	-	0.35	0.46	Ω
Forward transfer conductance (Note 4)	g_{fs}	$V_{DS}=10\text{V}, I_D=7\text{A}$	-	10	-	S
Input capacitance	C_{iss}	$V_{DS}=25\text{V}, V_{GS}=0\text{V}, f=1.0\text{MHz}$	-	2310	3182	pF
Output capacitance	C_{oss}		-	197	271	
Reverse transfer capacitance	C_{rss}		-	6.4	9	
Turn-on delay time (Note 4,5)	$t_{d(on)}$		$V_{DD}=250\text{V}, I_D=14\text{A}, R_G=25\Omega$	-	65	
Rise time (Note 4,5)	t_r	-		55	-	
Turn-off delay time (Note 4,5)	$t_{d(off)}$	-		144	-	
Fall time (Note 4,5)	t_f	-		58	-	
Total gate charge (Note 4,5)	Q_g	$V_{DS}=400\text{V}, V_{GS}=10\text{V}, I_D=14\text{A}$	-	33	45	nC
Gate-source charge (Note 4,5)	Q_{gs}		-	11	-	
Gate-drain charge (Note 4,5)	Q_{gd}		-	6	-	

Source-Drain Diode Ratings and Characteristics ($T_C=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Source current (DC)	I_S	Integral reverse diode in the MOSFET	-	-	14	A
Source current (Pulsed)	I_{SM}		-	-	56	A
Forward voltage	V_{SD}	$V_{GS}=0\text{V}, I_S=14\text{A}$	-	-	1.5	V
Reverse recovery time (Note 4,5)	t_{rr}	$I_S=14\text{A}, V_{GS}=0\text{V}$ $di_f/dt=100\text{A}/\mu\text{s}$	-	334	-	ns
Reverse recovery charge (Note 4,5)	Q_{rr}		-	2.8	-	μC

Note:

1. Repeated rating: Pulse width limited by safe operating area
2. $L=5.9\text{mH}, I_{AS}=14\text{A}, V_{DD}=50\text{V}, R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$
3. $I_S \leq 14\text{A}, di/dt \leq 200\text{A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$, Starting $T_J=25^\circ\text{C}$
4. Pulse test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$
5. Essentially independent of operating temperature typical characteristics

Electrical Characteristics Curve

Fig. 1 $I_D - V_{DS}$

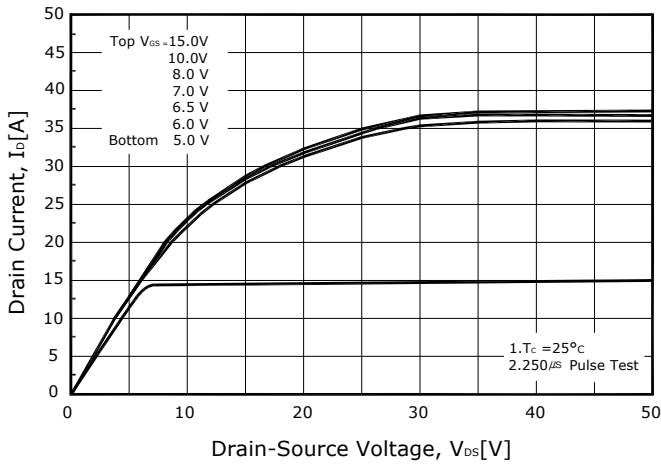


Fig. 2 $I_D - V_{GS}$

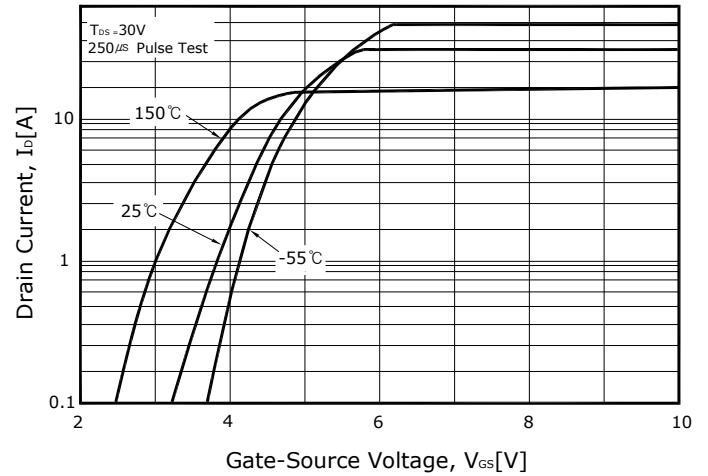


Fig. 3 $R_{DS(ON)} - I_D$

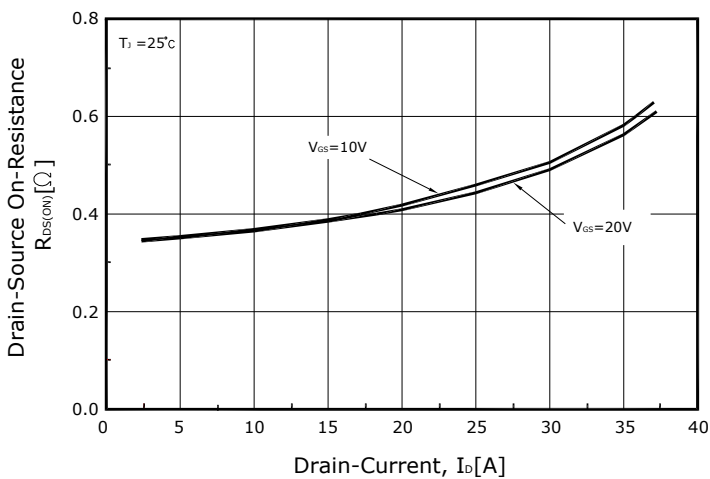


Fig. 4 $I_{DR} - V_{SD}$

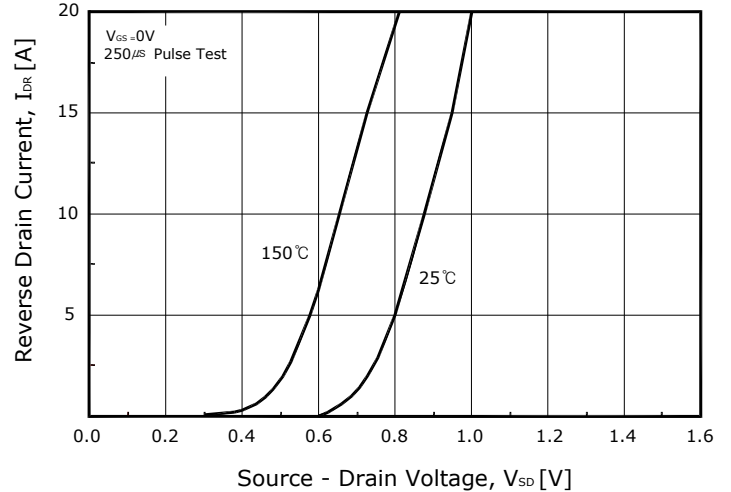


Fig. 5 Capacitance - V_{DS}

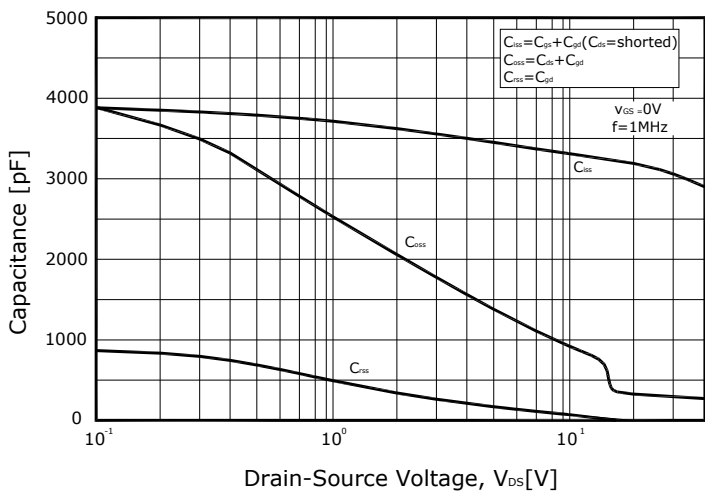
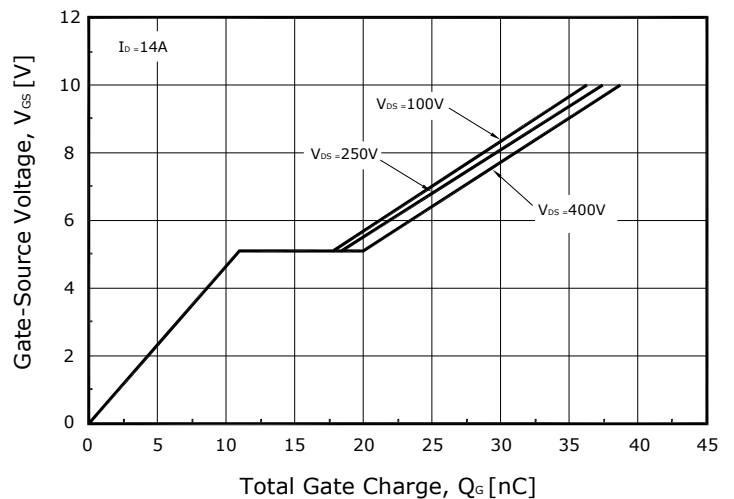


Fig. 6 $V_{GS} - Q_G$



Electrical Characteristics Curve (Continue)

Fig. 7 $BV_{DSS} - T_J$

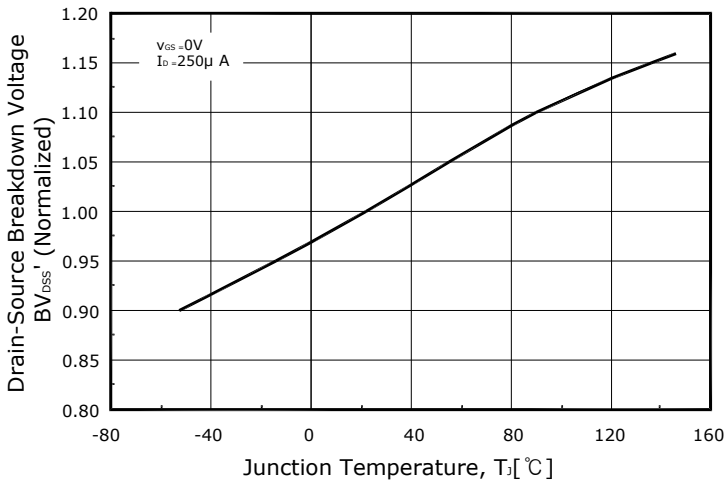


Fig. 8 $R_{DS(ON)} - T_J$

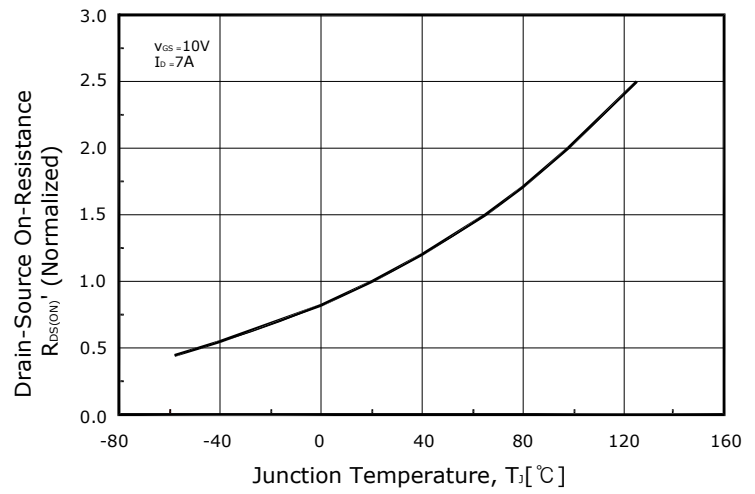


Fig. 9 $I_D - T_C$

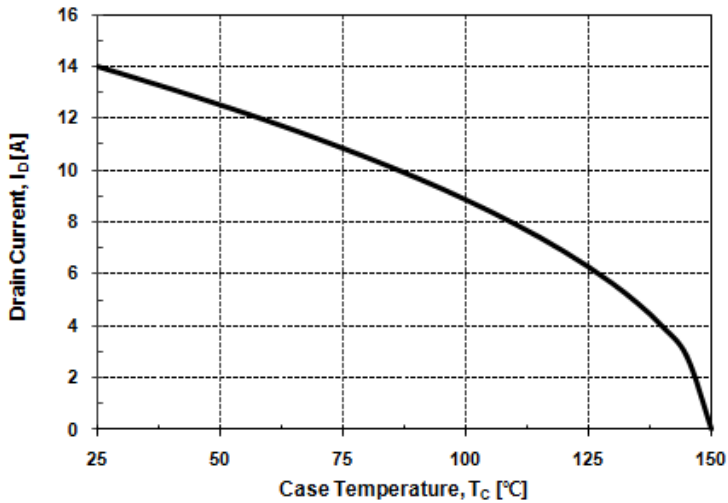


Fig. 10 Safe Operating Area

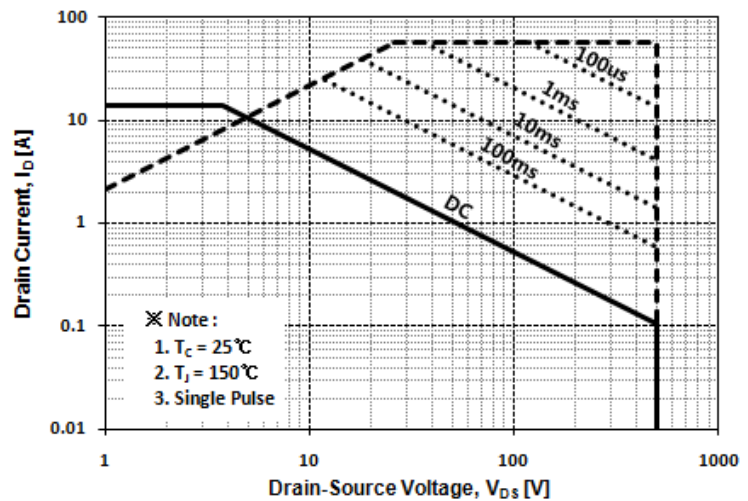


Fig. 11 Transient Thermal Impedance

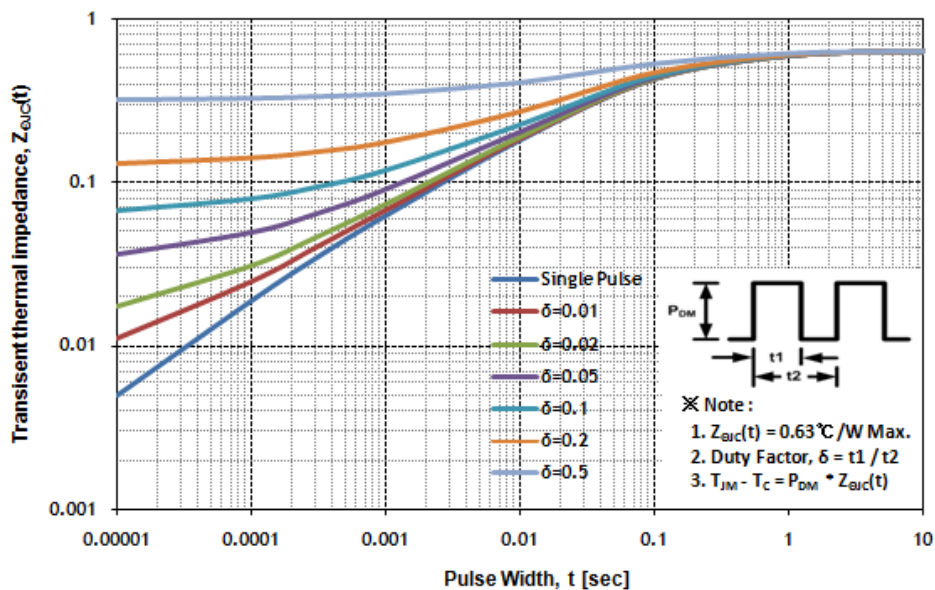


Fig. 12 Gate Charge Test Circuit & Waveform

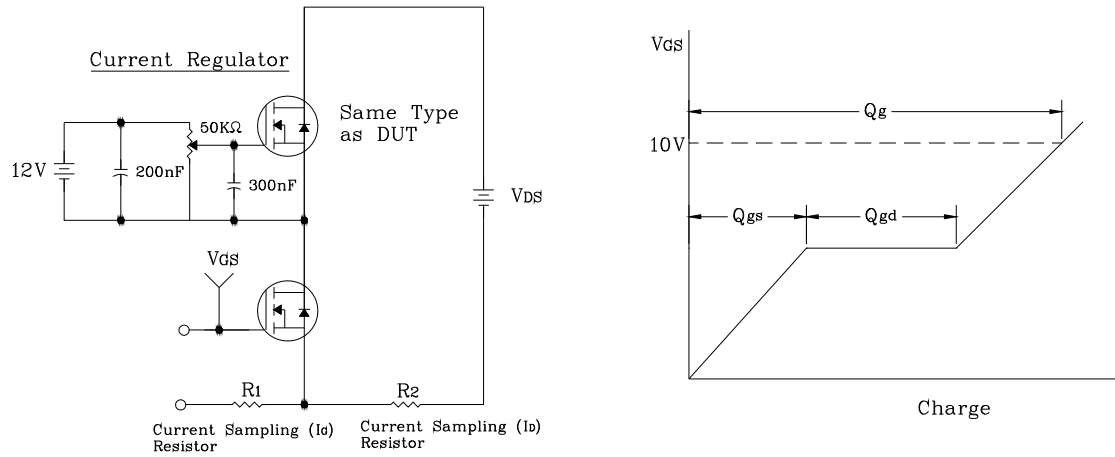


Fig. 13 Resistive Switching Test Circuit & Waveform

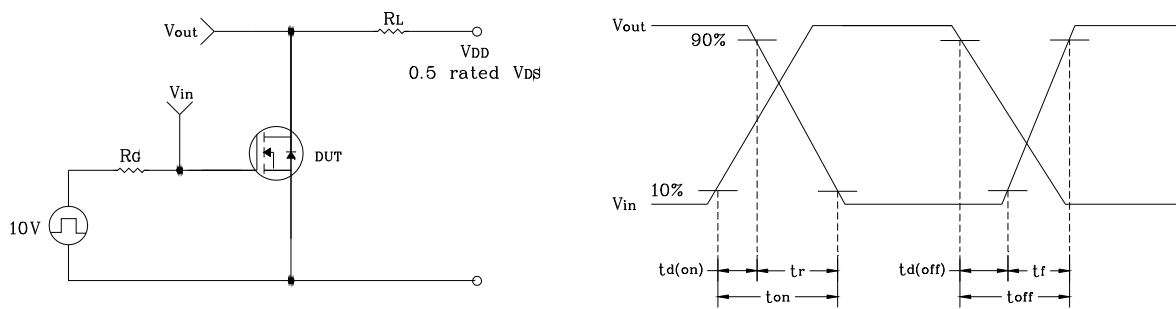


Fig. 14 E_{AS} Test Circuit & Waveform

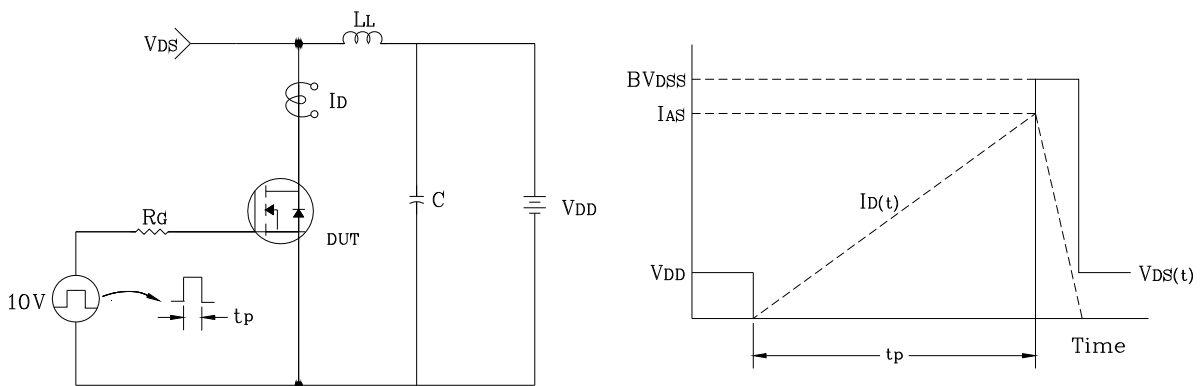
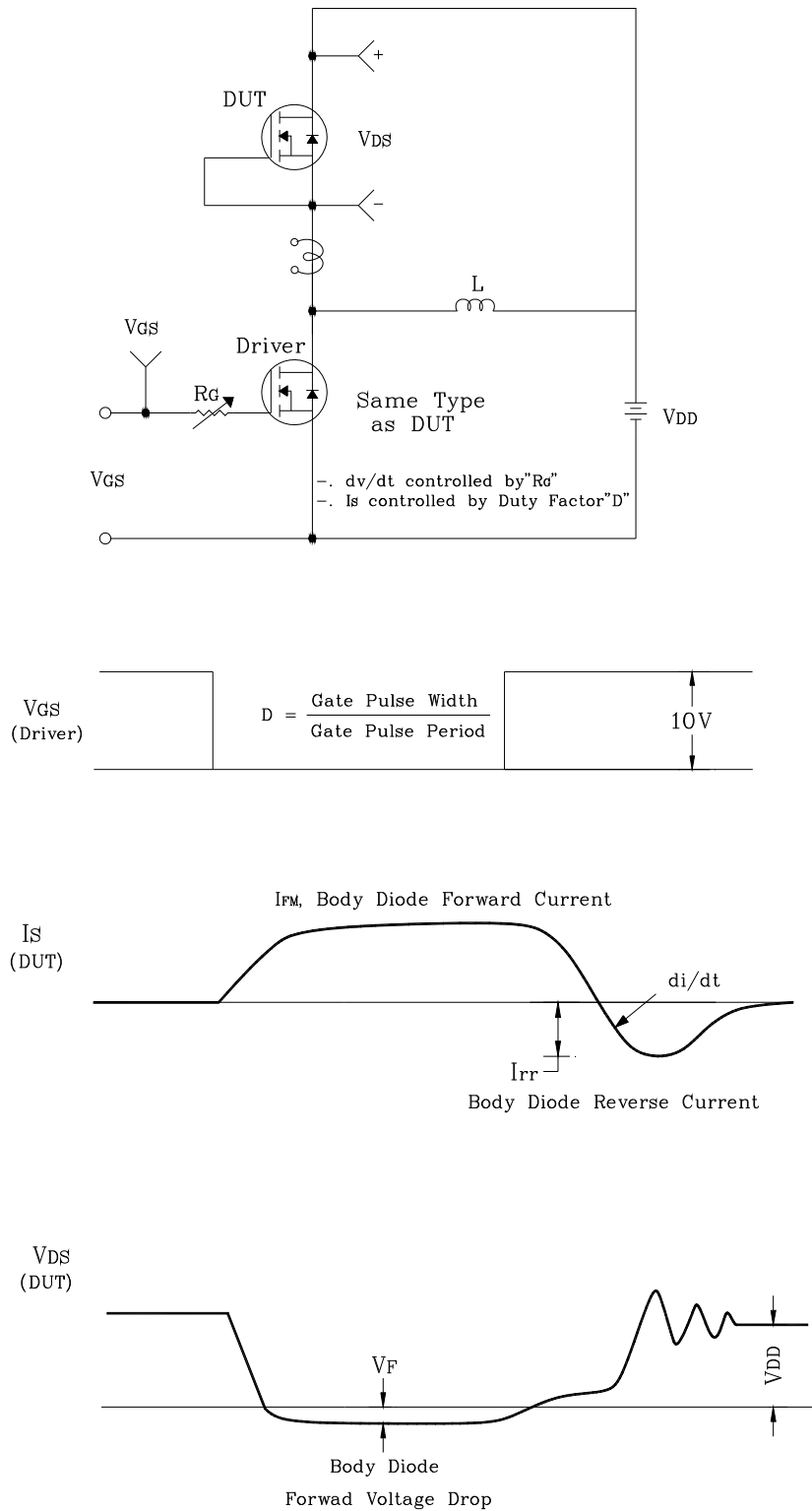
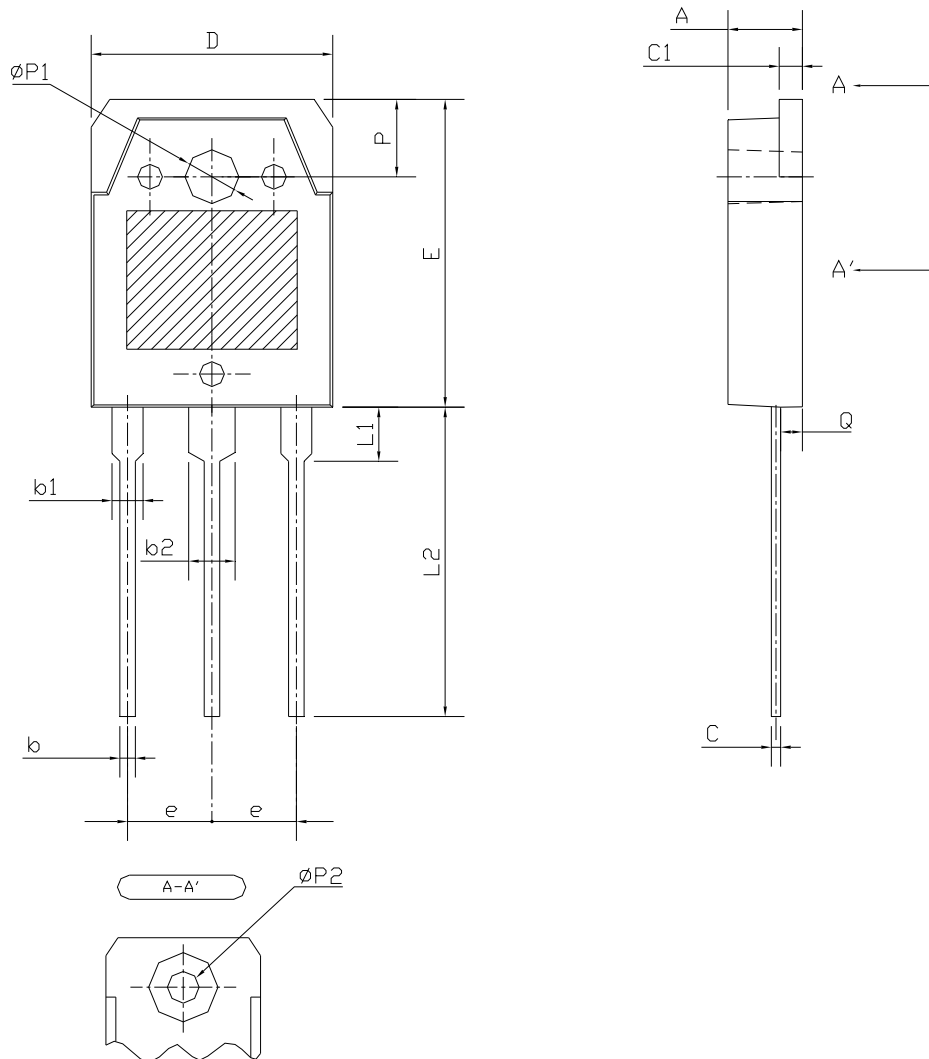


Fig. 15 Diode Reverse Recovery Time Test Circuit & Waveform



Package Outline Dimensions



SYMBOL	MIN	NOM	MAX
A	4.60	4.80	5.00
b	0.80	1.00	1.20
b1	1.80	2.00	2.20
b2	2.80	3.00	3.20
C	0.55	0.60	0.75
C1	1.45	1.50	1.65
D	15.40	15.60	15.80
E	19.70	19.90	20.10
e	5.15	5.45	5.75
L1	3.30	3.50	3.70
L2	19.80	20.00	20.20
P	4.80	5.00	5.20
$\phi P1$	3.30	3.40	3.50
$\phi P2$	(3.20)		
Q	1.20	1.40	1.60

The AUK Corp. products are intended for the use as components in general electronic equipment (Office and communication equipment, measuring equipment, home appliance, etc.).

Please make sure that you consult with us before you use these AUK Corp. products in equipments which require high quality and / or reliability, and in equipments which could have major impact to the welfare of human life(atomic energy control, airplane, spaceship, transportation, combustion control, all types of safety device, etc.). AUK Corp. cannot accept liability to any damage which may occur in case these AUK Corp. products were used in the mentioned equipments without prior consultation with AUK Corp..

Specifications mentioned in this publication are subject to change without notice.